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Heat transfer in an enclosure filled with a nanofluid and containing a heat-generating conductive body

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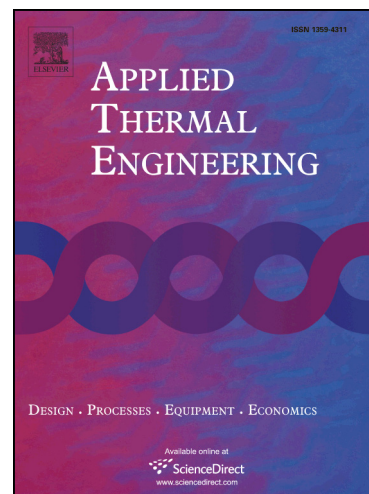
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